

## PARK & SUTTON LLP

3255 Wilshire Blvd., Suite 1110  
Los Angeles, California 90010  
Telephone: (213) 389-3777 Facsimile: (213) 389-3377

### DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION

As a below-named inventor, I hereby declare that: my residence, post office address, and citizenship are as stated below next to my name; I believe I am) the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

#### METHOD FOR COATING THERMOPLASTIC RESIN BEADS FOR USE IN IMITATION PEARLS

the specification of which is attached hereto. If not attached hereto, the specification was filed on \_\_\_\_\_ as  
(mm/dd/yyyy)

United States Application Number \_\_\_\_\_ ; and amended on \_\_\_\_\_ (if applicable) and/or  
(mm/dd/yyyy)

the specification was filed on \_\_\_\_\_ as PCT International Application Number \_\_\_\_\_ and was  
(mm/dd/yyyy)

amended on \_\_\_\_\_ (if applicable).  
(mm/dd/yyyy)

I have read the applicable statutes and rules reprinted on the reverse side of this declaration which I understand to describe subject matter which is material under 37 C.F.R. § 1.56(a).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a). I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

Application Number	Country	Date of Filing	Priority Claimed	
			Yes <input type="checkbox"/>	No <input type="checkbox"/>
			Yes <input type="checkbox"/>	No <input type="checkbox"/>

I hereby claim the benefit under Title 35, United States Code, 19(e) of any United States provisional application(s) as provisional application number \_\_\_\_\_ and filed on \_\_\_\_\_.  
(mm/dd/yyyy)

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

Application Number	Date of Filing	Status - Patented, Pending, or Abandoned

Send Correspondence to:

**John K. Park (Reg. No. 37,904)**

**Park & Sutton LLP**

3255 Wilshire Blvd., Suite 1110

Los Angeles, California 90010

Telephone: (213) 389-3777 Facsimile: (213) 389-3377

or Customer No. 29338

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application of any patent issuing thereon.

*Sole or First Inventor*

Given Name <b>YOUNG NAM</b>		Family Name <b>RHEE</b>	
Residence (City, State & Country) <b>Seoul, Republic of Korea</b>			Citizenship <b>Republic of Korea</b>
Mailing Address <b>201, Noblehouse, 100-1, BanPo-Dong, SeoCho-Gu, Seoul, Republic of Korea</b>			
Inventor's Signature <i>Young Nam Rhee</i>			Date <i>4/8/2004</i>

*Second Inventor*

Given Name <b>SANG MIN</b>		Family Name <b>RHEE</b>	
Residence (City, State & Country) <b>San Jose, CA</b>			Citizenship <b>U.S.A.</b>
Mailing Address <b>#10, 430 Galleria Dr., San Jose, CA 95134, U.S.A.</b>			
Signature <i>Sang Min Rhee</i>			Date <i>4/8/2004</i>

*Third Inventor*

Given Name		Family Name	
Residence (City, State & Country)			Citizenship
Mailing Address			
Signature			Date

*Fourth Inventor*

Given Name		Family Name	
Residence (City, State & Country)			Citizenship
Mailing Address			
Signature			Date

# **POWER OF ATTORNEY**

I hereby appoint the practitioners at Customer No. 29338 as my attorneys or agents to prosecute the United States Letters Patent Application titled:

**METHOD FOR COATING THERMOPLASTIC RESIN BEADS FOR USE IN IMITATION PEARLS**

and to transact all business with full power of substitution and revocation in the United States Patent and Trademark Office connected therewith, unless the inventor(s) or assignee(s) provides said practitioners with a written notice to the contrary.

Send Correspondence to:

**John K. Park (Reg. No. 37,904)**

**Park & Sutton LLP**

3255 Wilshire Blvd., Suite 1110

Los Angeles, California 90010

Telephone: (213) 389-3777 Facsimile: (213) 389-3377

or Customer No. 29338

I, the undersigned, declare that I am the owner of the above-mentioned application or, if the owner is a corporation, partnership, or other association, I am authorized to make this appointment on behalf of the owner, and I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application of any patent issuing thereon.

## *Sole or First Inventor*

Given Name <b>YOUNG NAM</b>	Family Name <b>RHEE</b>
Mailing Address 201, Noblehouse, 100-1, BanPo-Dong, SeoCho-Gu, Seoul, Republic of Korea	
Signature <i>Young Nam Rhee</i>	Date <i>4/8/2004</i>

## *Second Inventor*

Given Name <b>SANG MIN</b>	Family Name <b>RHEE</b>
Mailing Address #10, 430 Galleria Dr., San Jose, CA 95134, U.S.A.	
Signature <i>Sang Min Rhee</i>	Date <i>4/8/2004</i>

## *Third Inventor*

Given Name	Family Name
Mailing Address	
Signature	Date

## *Fourth Inventor*

Given Name	Family Name
Mailing Address	
Signature	Date